Code: ECMC2T1

I M.Tech - II Semester – Regular Examinations – AUGUST 2016

SOLID STATE MICROWAVE DEVICES & CIRCUITS (MICROWAVE & COMMUNICATION ENGINEERING)

Duration: 3 hours Max. Marks: 70 Answer any FIVE questions. All questions carry equal marks 1. a) Explain the structure of reflex klystron and give the expression for its power output and efficiency. 7 M b) Write a note on structure of a TWT. 7 M 2. a) Explain the physics and operation of PIN Diode. 7 M b) Give the equivalent circuit diagram of a varactor diode and describe its application. 7 M 3. a) Give the structure of Read diode and explain the 7 M avalanching process. b) Write a note on physics of IMPATT Diode. 7 M 4. a) Define GUNN effect. 7 M b) Explain different modes of operation of GUNN diode. 7 M

5.	. a) Explain the principle of operation and VI characteristics	
	Microwave BJT.	7 M
	b) Briefly explain the VI characteristics of JFET.	7 M
6.	. a) Give the equivalent circuit and operation of MESI	FET. 5 M
	b) Distinguish between MESFET and MOSFET.	4 M
	c) Give the structure of HEMT.	5 M
7.	. Write a short notes on the following.	
	a) Noise characterization	5 M
	b) Power gain	5 M
	c) Dynamic Range	4 M
8.	. a) Write a note on 3 port S- Parameters of Transistor	rs. 7 M
	b) Write a note on fixed frequency oscillator.	7 M